

TYN80W-1600T

Rev.03 - 14 November 2019

Product data sheet

1. General description

SCR

Planar passivated Silicon Controlled Rectifier in a TO247 plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ($T_{j(max)} = 150$ °C).

2. Features and benefits

- High junction operating temperature capability (T_{i(max)} = 150 °C)
- Very high current surge capability
- · Planar passivated for voltage ruggedness and reliability
- · High thermal cycling performance
- High voltage capability

3. Applications

- Line rectifying 50/60 Hz
- Soft start AC motor control
- DC motor control
- Power converter
- AC power control
- Lighting and temperature control
- Uninterruptible Power Supply (UPS)
- Solid State Relay (SSR)
- Traction battery charging

4. Quick reference data

Symbol	k reference data Parameter	Conditions	Values	Unit
Symbol	Farameter	Conditions	Values	Unit
Absolute ma	aximum rating			
V_{DRM}	repetitive peak off-state voltage		1600	V
$I_{T(RMS)}$	RMS on-state current	half sine wave; T _{mb} ≤ 117°C; <u>Fig. 1</u> ; <u>Fig. 2; Fig. 3</u>	126	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	850	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	930	А
T _j	junction temperature		150	°C

SCR

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 7; Fig. 8	-	-	80	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>	-	-	200	mA
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 11</u>	-	-	1.47	V
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 1070 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	1000	-	-	V/µs

5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode		А Д К G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

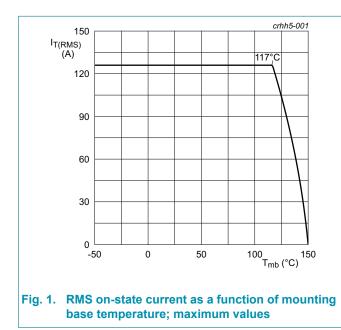
Orderable part number	Packing	Small packing	Package	Package
	method	quantity	version	issue date
TYN80W-1600TQ	Tube	30	TO247N	20-July-2016
		method	method quantity	method quantity version

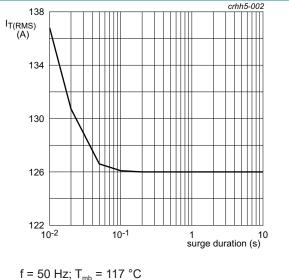
7. Limiting values

Table 4. Limiting values

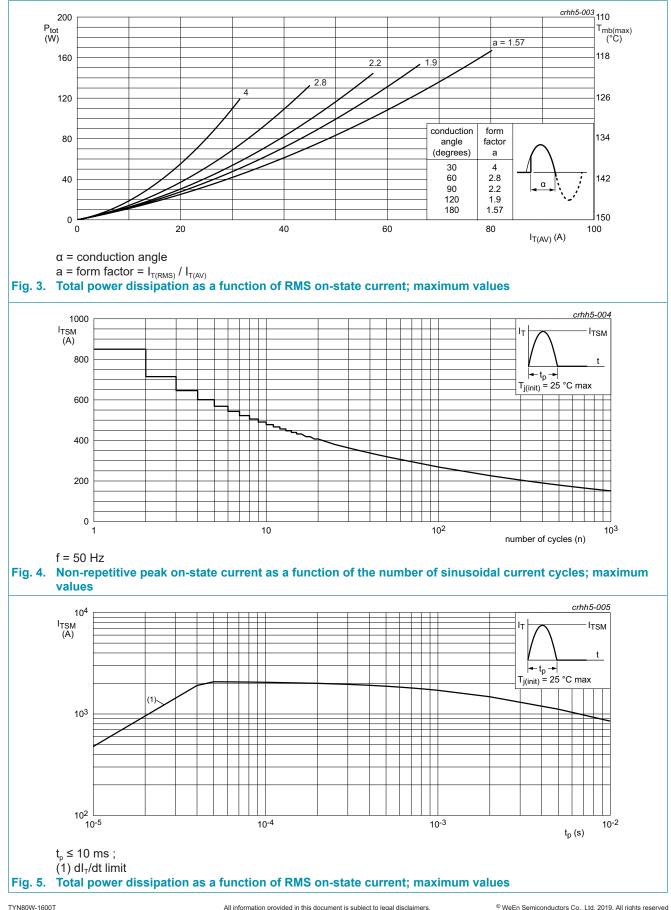
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{DRM}	repetitive peak off-state voltage		1600	V
V _{RRM}	repetitive peak reverse voltage		1600	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 117°C;	80	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 117°C; <u>Fig. 1; Fig. 2; Fig. 3</u>	126	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u>	850	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	930	А
l ² t	l ² t for fusing	t _p = 10 ms; sine wave	3610	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 200 mA	150	A/µs
I _{GM}	peak gate current		8	А
V _{RGM}	peak reverse gate voltage		5	V
P _{GM}	peak gate power		20	W
P _{G(AV)}	average gate power	over any 20 ms period	1	W
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C



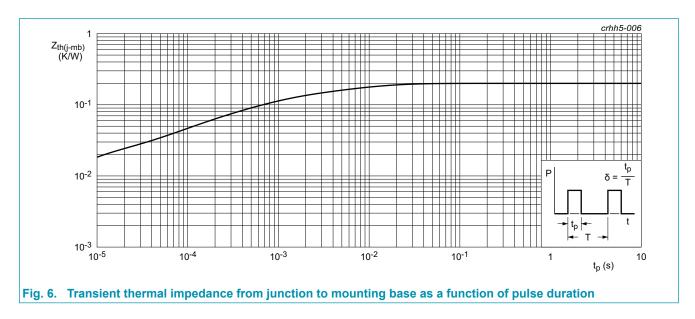






8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	-	0.2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W



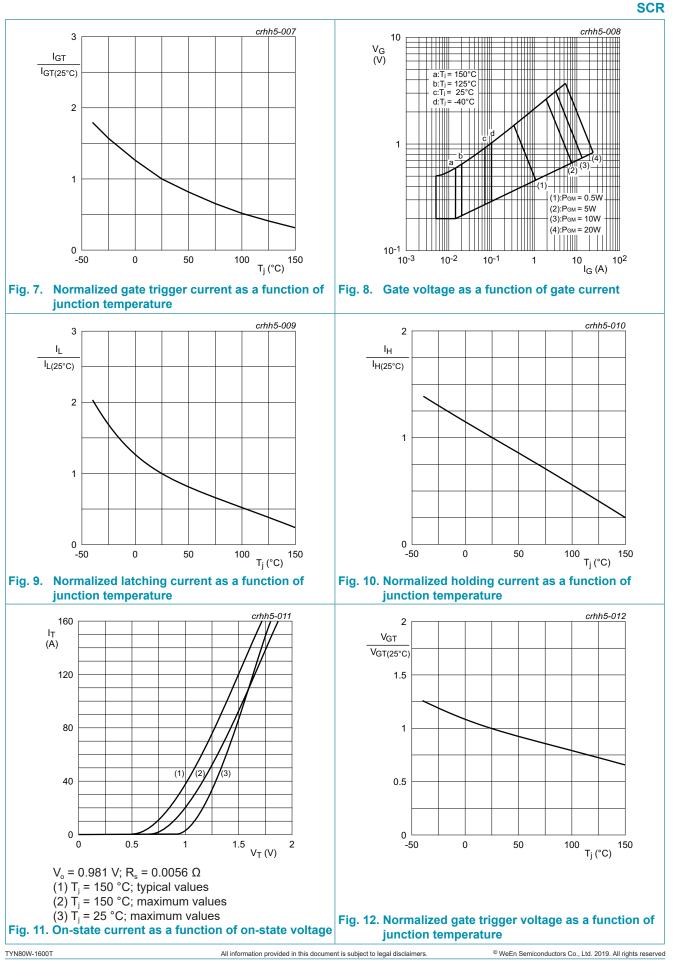
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9. Characteristics

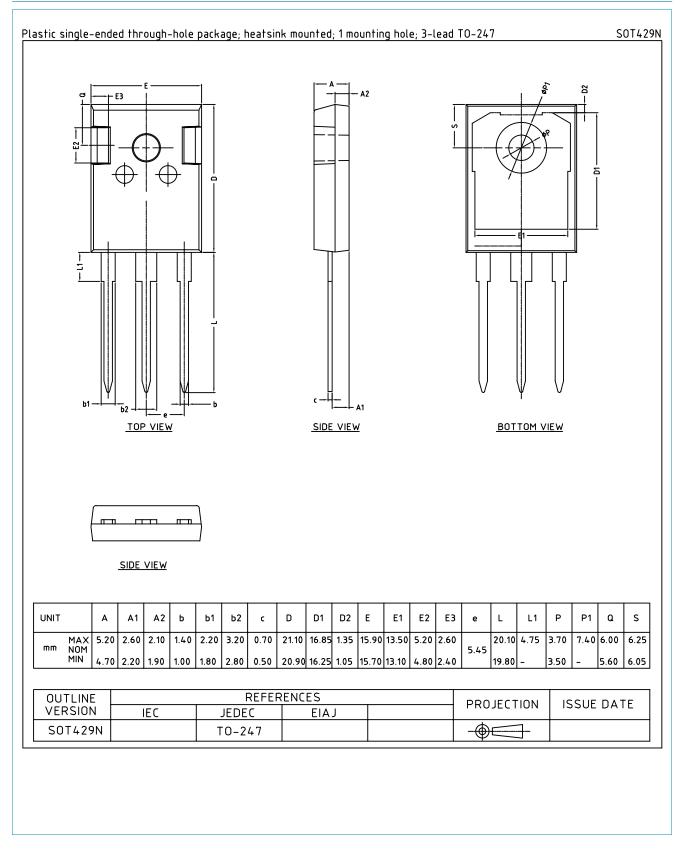
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · ·				_
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 7; Fig. 8	-	-	80	mA
I _L	latching current	V_{D} = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 9</u>	-	-	300	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>	-	-	200	mA
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 11</u>	-	-	1.47	V
V _{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 25 \text{ °C};$ Fig. 12	-	0.7	1	V
		V _D = 800 V; I _T = 0.1 A; T _j = 125 °C	0.25	0.4	-	V
I _D	off-state current	V _D = 1600 V; T _j = 25 °C	-	-	10	μA
		V _D = 1600 V; T _j = 125 °C	-	-	3	mA
I _R	reverse current	V _D = 1600 V; T _j = 25 °C	-	-	10	μA
		V _D = 1600 V; T _j = 125 °C	-	-	3	mA
Dynamic o	characteristics		I			
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 1070 V; T _j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit	1500	-	-	V/µs
		V_{DM} = 1070 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	1000	-	-	V/µs
t _{gt}	gate-controlled turn-on time $I_{TM} = 40 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ (dI_G/dt)_M = 0.5 \text{ A}/\mu s; T_J = 25 °C			2	-	μs
t _q	commutated turn-off time $V_{DM} = 1070 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ I}_{TM} = 80 \text{ A};$ $V_{R} = 25 \text{ V}; \text{ dV}_{D}/\text{dt} = 50 \text{ V}/\mu\text{s}; (\text{dI}_{T}/\text{dt})_{M} = 30 \text{ A}/\mu\text{s}; (V_{DM} = 67\% \text{ of } \text{V}_{DRM})$			150	-	μs

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TYN80W-1600T



10. Package outline



TYN80W-1600T Product data sheet

11. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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